Corporate News

LPKF receives further order for production equipment in the Advanced Packaging area

Order volume in the mid-single-digit million-euro range – further customer adopts LIDE technology for production

Garbsen, 16 November 2026 – LPKF Laser & Electronics SE has received an order in the mid-single-digit million-euro range from a leading Asian manufacturer of components for Advanced Semiconductor Packaging. The customer will use the LIDE (Laser Induced Deep Etching) systems to produce glass components for Advanced Packaging architectures in the field of co-packaged optics.

LPKF has many years of expertise in laser-based precision processing for the microstructuring of glass. LIDE technology enables the manufacture of high-precision glass components for demanding applications in Advanced Packaging for high-performance chips. In the field of co-packaged optics, it creates the conditions necessary for the precise positioning of optical components, thereby supporting their integration into modern chip packages.

With this order, LPKF gains another customer that uses LIDE technology in production. Part of the order is expected to be delivered before the end of the current financial year. Delivery of the remaining portion is scheduled for the first quarter of 2027.

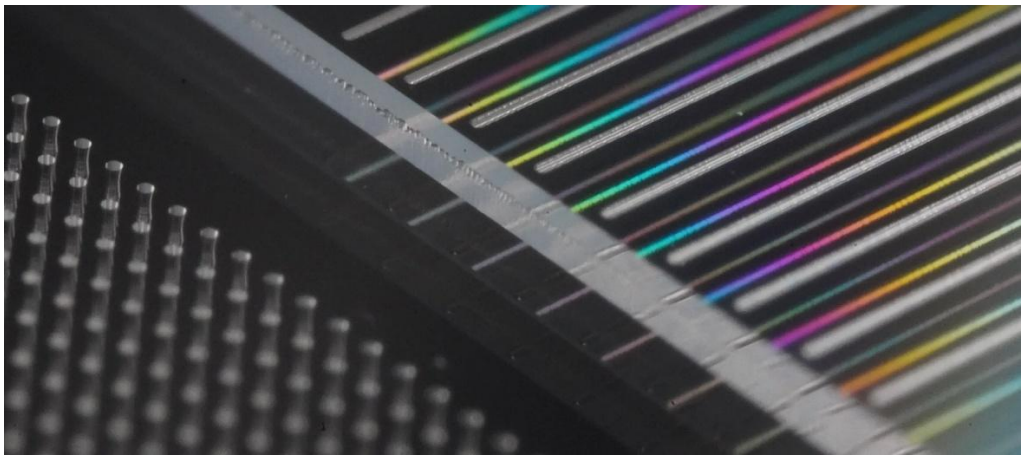
The order marks another step for LPKF on its path to establishing itself as a supplier for the production of glass-based Advanced Packaging. The transition of yet another customer from qualification to production use is in line with LPKF's expectations and confirms the progress made in this application area.

Contact:
Bettina Schäfer
bettina.schaefer@lpkf.com
Phone: +49 5131 7095-1382
Fax +49 5131 7095-90

Management Board:
Dr. Klaus Fiedler (CEO)
Peter Mümmler (CFO)

LPKF Laser & Electronics SE
Osteriede 7, 30827 Garbsen, Germany

Stock:
SDAX / Prime Standard
LPK
ISIN DE0006450000
www.lpkf.com



LPKF's NEXAR product platform enables customers to structure glass with the highest precision and use it in the latest Advanced Packaging architectures for high-performance computing.

About LPKF

LPKF is a leading international technology group for laser-based manufacturing solutions. The company develops high-precision, energy-efficient, and sustainable technologies for demanding industries, including the semiconductor, electronics, solar, and medical technology sectors. With its patented LIDE technology, LPKF sets standards in glass processing for advanced semiconductor packaging. A global network, approximately 700 employees, and decades of development expertise enable innovative solutions across the entire value chain. LPKF is headquartered in Garbsen, Germany, and is listed on the SDAX of the German Stock Exchange (LPK; ISIN DE0006450000).

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Contact:
Bettina Schäfer
bettina.schaefer@lpkf.com
Phone: +49 5131 7095-1382
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